

Notice of Allowability	Application No.	Applicant(s)
	10/796,887	SCHEID, DAVID RALPH
	Examiner	Art Unit
	Khanh B. Duong	2822
The MAILING DATE of this communication appears on the cover sheet with the correspondence address All claims being allowable, PROSECUTION ON THE MERITS IS (OR REMAINS) CLOSED in this application. If not included herewith (or previously mailed), a Notice of Allowance (PTQL-85) or other appropriate communication will be mailed in due course. THIS NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIGHTS. This application is subject to withdrawal from issue at the initiative of the Office or upon petition by the applicant. See 37 CFR 1.313 and MPEP 1308.		
1. This communication is responsive to the amendment filed on January 9, 2006.		
2. The allowed claim(s) is/are <u>1-5,7-18 and 26</u> .		
<ul> <li>3. Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some* c) None of the: <ol> <li>Certified copies of the priority documents have been received.</li> <li>Certified copies of the priority documents have been received in Application No.</li> <li>Copies of the certified copies of the priority documents have been received in this national stage application from the International Bureau (PCT Rule 17.2(a)).</li> </ol> </li> <li>* Certified copies not received:</li> </ul>		
Applicant has THREE MONTHS FROM THE "MAILING DATE" of this communication to file a reply complying with the requirements noted below. Failure to timely comply will result in ABANDONMENT of this application.  THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		
4. A SUBSTITUTE OATH OR DECLARATION must be submitted. Note the attached EXAMINER'S AMENDMENT or NOTICE OF INFORMAL PATENT APPLICATION (PTO-152) which gives reason(s) why the oath or declaration is deficient.		
5. CORRECTED DRAWINGS (as "replacement sheets") must be submitted.		
(a) ☐ including changes required by the Notice of Draftsperson's Patent Drawing Review ( PTO-948) attached		
1)  hereto or 2)  to Paper No./Mail Date		
(b) ☐ including changes required by the attached Examiner's Amendment / Comment or in the Office action of Paper No./Mail Date		
Identifying indicia such as the application number (see 37 CFR 1.84(c)) should be written on the drawings in the front (not the back) of each sheet. Replacement sheet(s) should be labeled as such in the header according to 37 CFR 1.121(d).		
6. DEPOSIT OF and/or INFORMATION about the deposit of BIOLOGICAL MATERIAL must be submitted. Note the attached Examiner's comment regarding REQUIREMENT FOR THE DEPOSIT OF BIOLOGICAL MATERIAL.		
Attachment(s) 1. ☐ Notice of References Cited (PTO-892)	5. ☐ Notice of Informal Pa	atent Application (PTO-152)
2. Notice of Draftperson's Patent Drawing Review (PTO-948)	6. Interview Summary (	(PTO-413),
3. Information Disclosure Statements (PTO-1449 or PTO/SB/08 Paper No./Mail Date	Paper No./Mail Date 8), 7. ⊠ Examiner's Amendm	e ent/Comment
Examiner's Comment Regarding Requirement for Deposit of Biological Material	8. 🛛 Examiner's Statemen	nt of Reasons for Allowance
2. Disinglian material	9.	
		·

Application/Control Number: 10/796,887

Art Unit: 2822

### **DETAILED ACTION**

## Response to Amendment

This Office Action is in response to the amendment filed on January 9, 2006.

Accordingly, claim 6 was canceled, claims 1-4, 7, 10, 11, 13-16 and 18 were amended, and new claims 26 and 27 were added.

Newly submitted claim 27 is directed to an invention that is independent or distinct from the invention originally claimed for the following reasons: claim 27 is drawn to a product-by-process (semiconductor device), classified in class 257, subclass 678. Product-by-process claims are not limited to the manipulations of the recited steps, only the structure implied by the steps. "[E]ven though product-by-process claims are limited by and defined by the process, determination of patentability is based on the product itself. The patentability of a product does not depend on its method of production. If the product in the product-by-process claim is the same as or obvious from a product of the prior art, the claim is unpatentable even though the prior product was made by a different process." In re Thorpe, 777 F.2d 695, 698, 227 USPQ 964, 966 (Fed. Cir. 1985).

Since applicant has received an action on the merits for the originally presented invention, this invention has been constructively elected by original presentation for prosecution on the merits. Accordingly, claim 27 is withdrawn from consideration as being directed to a non-elected invention. See 37 CFR 1.142(b) and MPEP § 821.03.

Thus, claims 19-25 and 27 are withdrawn from consideration as being directed to a nonelected invention.

Currently, claims 1-5 and 7-27 are pending.

### **EXAMINER'S AMENDMENT**

An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

The application has been amended as follows:

In the claims:

Please cancel claims 19-25 and 27.

# Allowable Subject Matter

Claims 1-5, 7-18 and 26 are allowed.

The following is an examiner's statement of reasons for allowance: none of the prior art of record, taken alone or in combination, fairly discloses all the limitations as claimed.

Re claim 1, none of the prior art of record fairly shows or suggests the following limitations in combination with the rest of the limitations in the claim: removing the substrate from the bottom sides of at least two of the plurality of semiconductor dice wherein removing includes the step of backgrinding the substrate from the at least two semiconductor dice; and bending the thin film interconnect at the one or more bending regions.

Re claim 10, none of the prior art of record fairly shows or suggests the following limitations in combination with the rest of the limitations in the claim: removing the substrate from the bottom sides of at least two of the plurality of semiconductor dice wherein the step of removing the substrate comprises the step of performing laser ablation; and bending the thin film interconnect at the one or more bending regions.

Application/Control Number: 10/796,887

Art Unit: 2822

Re claim 15, none of the prior art of record fairly shows or suggests the following limitations in combination with the rest of the limitations in the claim: removing the substrate from the bottom sides of at least two of the plurality of semiconductor dice; singulating at least two of the plurality of semiconductor dice into sub-pluralities of semiconductor die by etching dielectric layers along unused sides of the dice; and bending the thin film interconnect at the one or more bending regions.

Re claim 16, none of the prior art of record fairly shows or suggests the following limitations in combination with the rest of the limitations in the claim: backgrinding the substrate from the bottom sides of at least two of the plurality of semiconductor dice; and bending the flexible member at the bending region to form a multidimensional interconnected dice structure.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Khanh B. Duong whose telephone number is (571) 272-1836. The examiner can normally be reached on 10:00-6:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Zandra Smith, can be reached on (571) 272-2429. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

**KBD** 

Supervisory Patent Examiner